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March 2016

NTC Thermistors

Element

NTCDS·NTCGF series

NTCDS Glass-encapsulated NTC thermistors

NTCGF Resin coated NTC thermistors



NTC Thermistors

Element

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders

Overview of the NTCDS · NTCGF Series

FEATURES

- This series features a glass-sealed construction identical to that of DHDs (Double Heatsink Diodes). They are thus highly reliable and resistant to high relative humidity.
- Tight tolerances are maintained in resistance vs. temperature characteristics.
- The application of semiconductor mass production techniques has resulted in considerable size reduction and improved consistency.

NTCDS series Glass-encapsulated NTC thermistors Dimensional code 3 (3.0×ø1.8mm) NTCGF series NTCGF series

Resin coated NTC thermistors

Dimensional code 5 (Resin coated shape)

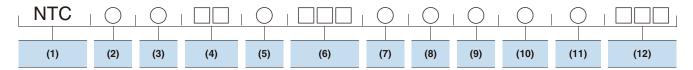


- RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. http://product.tdk.com/en/environment/rohs/
- O Halogen-free: Indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.



Overview of the NTCDS · NTCGF Series

PART NUMBER CONSTRUCTION



(1) This code denotes NTC thermistors.

(2) Structural classification code

D	Glass-encapsulated shape(Axial lead type)
G	Multilayer element

(3) Assembly classification code

S	Without processing
Α	Folded radial lead wire
В	Folded radial lead wire with insulation tube
С	Short cut lead wire
D	Kinked lead wire with insulation tube
E	Kinked lead wire
F	Resin coated NTC thermistors
Z	Coating product
X	Others

(4) B constant(Resistance temperature characteristics)

This code indicates the value of B constant using a combination of one numeric and one alphabetic character.

Numeric code	B constant(K)
2	2000
3	3000
4	4000

Note: Although B constants are expressed as 3A, 3B, 4A, 4B, etc. using these two tables, the alphabetic characters do not denote tolerances; they have the meaning shown in the example below.

(Example) 3A=3010(K) 3A=3050(K)

That is, the alphabetic character(in this example, A) indicates the range of values that can be specified by the thermistor user.

Alphabetic code	B constant(K)
A	0 to 50
В	51 to 100
С	101 to 150
D	151 to 200
B C D E	201 to 250
F	251 to 300
G	301 to 350
Н	351 to 400
J K	401 to 450
K	451 to 500
L	501 to 550
M	551 to 600
N	601 to 650
Р	651 to 700
Q	701 to 750
R	751 to 800
S T	801 to 850
T	851 to 900
U	901 to 950
V	951 to 999

(5) B constant tolerance

This code indicates tolerances using the following code.

	9	
Code	Tolerance(%)	
F	±1	
G	±2	
Н	±3	
J	±5	
K	±10	
X	Others	

(6) Nominal resistance

This code indicates the resistance value existing at the specified ambient temperature by two significant digits followed by the digit 0(zero).

(Example)

470Ω	471	
5kΩ	502	
10kΩ	103	
150kΩ	154	

(7) Nominal resistance tolerance

Tolerance is identified by the following codes.

Code	Tolerance(%)
F	±1
G	±2
Н	±3
J	±5
K	±10
X	Others

(8) Ambient temperature for nominal resistance

Ambient temperatures for specified nominal-resistance values are indicated using the following codes.

Code	Ambient temperature(°C)
A	-20
В	0
С	25
D	100
E	200
F	300
G	20
X	Others

(9) Dimensional code

3	3018 type	
4	4020 type	
5	Resin DIP shape(Resin DIP type: G)	

(10) Plating specification code of lead wire

, , ,	
N	Ni
S	Sn

(11) Packaging style

В	Bulk	
Т	Taping(Tape width: 52mm)	
K	Taping(Tape width: 26mm)	
X	Others	

(12) TDK internal code

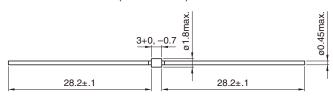
SENSORS



NTCDS Series (Glass-encapsulated NTC thermistors, Dimensional code 3)

■SHAPE & DIMENSIONS

□Dimensional code 3 (3.0×ø1.8mm)





■ CHARACTERISTICS

Dimensional code	3(3.0×ø1.8mm)
Heat dissipation constant[in still air]	1mW/°C
Thermal time constant[in still air]	10s max.
Insulation resistance[between lead and glass]	50MΩ min.[DC.500V]

Temperature coefficient

The relationship between temperature coefficient $\boldsymbol{\alpha}$ and B constant can be expressed as follows:

$$\alpha = -\frac{B}{T_2} \times 100(\%)^{\circ}C_2$$

Example: The temperature coefficient at 20°C with B=3400K can be calculated at -4%/°C.

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLES

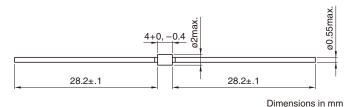
Part No.	Nominal re	esistance	Resistance	B constant		Lead wire	Operating
	(0°C)	(100°C)	(25°C)			plating	temperature ranges
NTCDS3HG552HB3N	5.499 k Ω	_	2.000 k Ω	B25/85: 3392K±2%	B0/100: 3366K±2%		
NTCDS3HG602HB3N□	6kΩ	_	2.186kΩ	B25/85: 3392K±2%	B0/100: 3366K±2%		
NTCDS3HG273HB3N□	27.18kΩ	_	10.00kΩ	B25/85: 3400K±2%	B0/100: 3368K±2%	_	
NTCDS3KG471HD3N□	_	$0.470 \mathrm{k}\Omega$	$4.961k\Omega$	B25/85: 3480K±2%	B0/100: 3450K±2%]	
NTCDS3KG153HB3N□	15k Ω	_	5.369 k Ω	B25/85: 3480K±2%	B0/100: 3450K±2%		
NTCDS3KG303HB3N□	30 k Ω	_	10.74kΩ	B25/85: 3480K±2%	B0/100: 3450K±2%		
NTCDS3LG181HD3N□	_	0.184 k Ω	$1.991 \mathrm{k}\Omega$	B25/85: 3528K±2%	B0/100: 3503K±2%	Ni	–40 to 250°C
NTCDS3LG161HD3N□	_	0.1553 k Ω	1.684kΩ	B25/85: 3528K±2%	B0/100: 3503K±2%	INI	-40 to 250 C
NTCDS3NG802HB3N□	$8.013k\Omega$	_	$2.677k\Omega$	B25/85: 3650K±2%	B0/100: 3645K±2%	_	
NTCDS3UG661HD3N□	_	$0.662 \mathrm{k}\Omega$	9.382 k Ω	B25/85: 3940K±2%	B0/100: 3932K±2%		
NTCDS4AG173HB3N□	17kΩ	_	4.918 k Ω	B25/85: 4000K±2%	B0/100: 3999K±2%	-	
NTCDS4AG353HB3N□	34.67 k Ω	_	10.00kΩ	B25/85: 4000K±2%	B0/100: 3999K±2%		
NTCDS4AG993HB3N□	99.91k Ω	_	30.00 k Ω	B25/85: 3992K±2%	B0/100: 3970K±2%	_	
NTCDS4AG332HD3N□	_	3.3 k Ω	49.12kΩ	B25/85: 3992K±2%	B0/100: 3970K±2%		
NTCDS3HG552HB3S□	5.499 k Ω	_	2.000 k Ω	B25/85: 3392K±2%	B0/100: 3366K±2%		
NTCDS3KG471HD3S	_	$0.470 \mathrm{k}\Omega$	$4.961 k\Omega$	B25/85: 3480K±2%	B0/100: 3450K±2%	Sn	-40 to 160°C
NTCDS3UG661HD3S	_	$0.662 k\Omega$	9.382kΩ	B25/85: 3940K±2%	B0/100: 3932K±2%		



NTCDS Series (Glass-encapsulated NTC thermistors, Dimensional code 4)

■SHAPE & DIMENSIONS

□Dimensional code 4 (4.0×ø2.0mm)





■ CHARACTERISTICS

Dimensional code	4(4.0×ø2.0mm)
Heat dissipation constant[in still air]	2mW/°C
Thermal time constant[in still air]	20s max.
Insulation resistance[between lead and glass]	50MΩ min.[DC.500V]

Temperature coefficient

The relationship between temperature coefficient $\boldsymbol{\alpha}$ and B constant can be expressed as follows:

$$\alpha = -\frac{B}{T^2} \times 100(\%^{\circ}C)$$

Example: The temperature coefficient at 20°C with B=3400K can be calculated at -4%/°C.

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLES

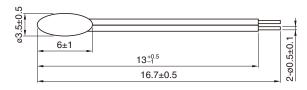
Part No.	Nominal re	esistance	Resistance	B constant		Lead wire	Operating
	(0°C)	(100°C)	(25°C)			plating	temperature ranges
NTCDS3HG552HB4N□	$5.499 \mathrm{k}\Omega$	_	2.000 k Ω	B25/85: 3392K±2%	B0/100: 3366K±2%		−40 to 250°C
NTCDS3HG602HB4N□	6kΩ	_	$2.186k\Omega$	B25/85: 3392K±2%	B0/100: 3366K±2%		
NTCDS3HG273HB4N□	27.18kΩ	_	10.00kΩ	B25/85: 3400K±2%	B0/100: 3368K±2%	_	
NTCDS3KG471HD4N□	_	$0.470 \mathrm{k}\Omega$	$4.961k\Omega$	B25/85: 3480K±2%	B0/100: 3450K±2%	Ni	
NTCDS3KG153HB4N□	15kΩ	_	$5.369 k\Omega$	B25/85: 3480K±2%	B0/100: 3450K±2%		
NTCDS3KG303HB4N□	$30k\Omega$	_	10.74kΩ	B25/85: 3480K±2%	B0/100: 3450K±2%		
NTCDS3LG181HD4N□	_	$0.184 \mathrm{k}\Omega$	$1.991 \mathrm{k}\Omega$	B25/85: 3528K±2%	B0/100: 3503K±2%		
NTCDS3LG161HD4N□	_	0.1553 k Ω	1.684kΩ	B25/85: 3528K±2%	B0/100: 3503K±2%		
NTCDS3NG802HB4N□	8.013 k Ω	_	$2.677k\Omega$	B25/85: 3650K±2%	B0/100: 3645K±2%		
NTCDS3RG642HB4N□	6.418 k Ω	_	$2.016k\Omega$	B25/85: 3800K±2%	B0/100: 3792K±2%		
NTCDS3SG652HB4N□	$6.508 \mathrm{k}\Omega$	_	$2.020 k\Omega$	B25/85: 3850K±2%	B0/100: 3834K±2%		
NTCDS3UG661HD4N	_	$0.662 k\Omega$	9.382 k Ω	B25/85: 3940K±2%	B0/100: 3932K±2%		
NTCDS4AG173HB4N□	$17k\Omega$	_	4.918 k Ω	B25/85: 4000K±2%	B0/100: 3999K±2%		
NTCDS4AG353HB4N□	$34.67 k\Omega$	_	10.00kΩ	B25/85: 4000K±2%	B0/100: 3999K±2%		
NTCDS4AG993HB4N□	99.91k Ω	_	30.00 k Ω	B25/85: 3992K±2%	B0/100: 3970K±2%		
NTCDS4AG332HD4N	_	3.3 k Ω	49.12kΩ	B25/85: 3992K±2%	B0/100: 3970K±2%		
NTCDS3HG602HB4S	6kΩ	_	$2.186k\Omega$	B25/85: 3392K±2%	B0/100: 3366K±2%	- - Sn	-40 to 160°C
NTCDS3KG153HB4S	15kΩ	_	5.369kΩ	B25/85: 3480K±2%	B0/100: 3450K±2%		
NTCDS3KG303HB4S	30kΩ	_	10.74kΩ	B25/85: 3480K±2%	B0/100: 3450K±2%		
NTCDS4AG353HB4S	34.67kΩ	_	10.00kΩ	B25/85: 4000K±2%	B0/100: 3999K±2%		



NTCGF Series (Resin coated NTC thermistors, Dimensional code 5)

■SHAPE & DIMENSIONS

□Dimensional code 5



Dimensions in mm



■ CHARACTERISTICS

Dimensional code	5(Resin DIP type)
Heat dissipation constant[in still air]	4mW/°C
Thermal time constant[in still air]	30s max.
Insulation resistance[between lead and thermistor]	5MΩ min.[DC.500V]

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLES

Part No.	Nominal resistance	Resistance	B constant		Lead wire	Operating
	(0°C)	(25°C)			plating	temperature ranges
NTCGF3LG222HC5SB	6.204kΩ	2.185kΩ	B25/85: 3535K±2%	B0/100: 3505K±2%	Sn	–40 to 125°C